EVERLIGHT AMERICAS

DATASHEET

EAST1613BGA0



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow

solder process.

- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS
- compliant version.

Descriptions

- The EAST1613 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

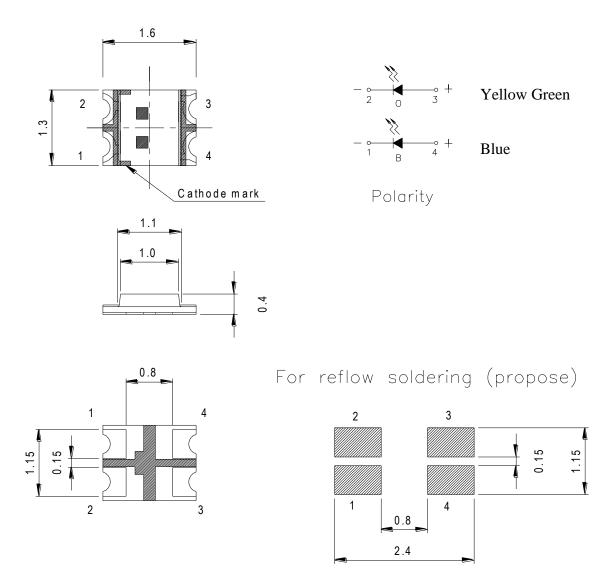
Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Туре	Material	Emitted Color	Resin Color	
G7	AlGaInP	Brilliant Yellow Green		
BH	InGaN	Blue	Water Clear	

Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Reverse Voltage Forward Current	VR	5		
Forward Current			V	
	IF	G7:25 BH:25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	G7:60 BH:100	mA	
Power Dissipation	Pd	G7:60 BH:110	mW	
Electrostatic Discharge(HBM)	ESD	G7:2000 V BH:150 V		
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90 °C		
Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.		

Absolute Maximum Ratings (Ta=25°C)

Parameter	Parameter Symbo		Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	Iv	G7	22.5	36.0		mcd	IF=20mA	
		BH	22.5	36.0				
Viewing Angle	2	θ 1/2		120		deg	IF=20mA	
	λp	G7		575				
Peak Wavelength		BH		468		nm	IF=20mA	
Dominant Wavelength	λd	G7		573			IF=20mA	
Dominant wavelength		BH		470		nm	IF-2011A	
Spectrum Radiation	Δλ	λ G7		20			I- 20- A	
Bandwidth		BH		35		nm	IF=20mA	
Forward Voltage	VF	G7	1.7	2.0	2.4	v	IF=20mA	
Forward Voltage		BH	2.7	3.3	3.7	v	n=2011A	
Dama Carrier	IR	G7	0		10			
Reverse Current		BH			50	μA	Vr=5V	

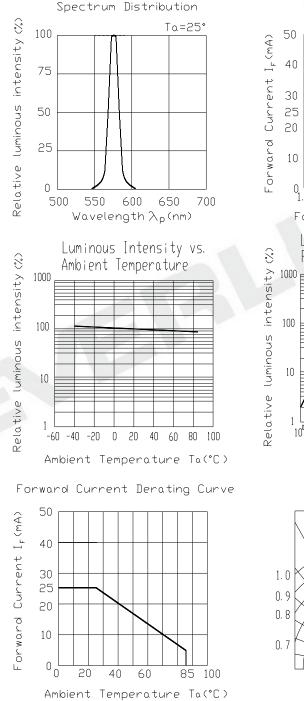
Electro-Optical Characteristics (Ta=25°C)

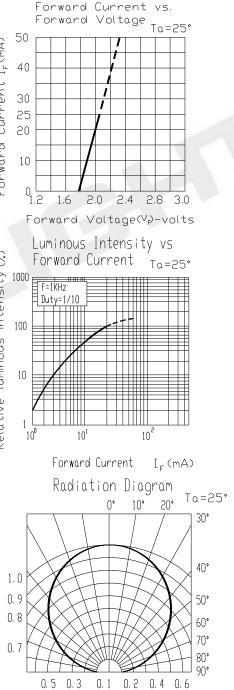
Notes:

1.Tolerance of Luminous Intensity ±11%

Typical Electro-Optical Characteristics Curves

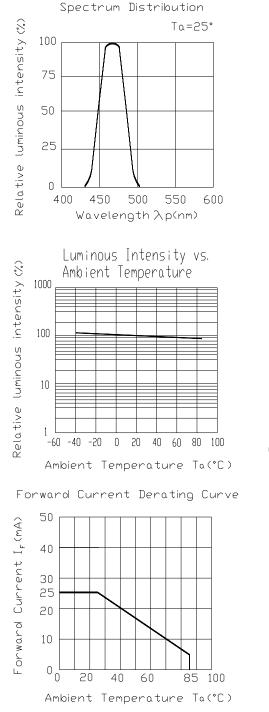
G7

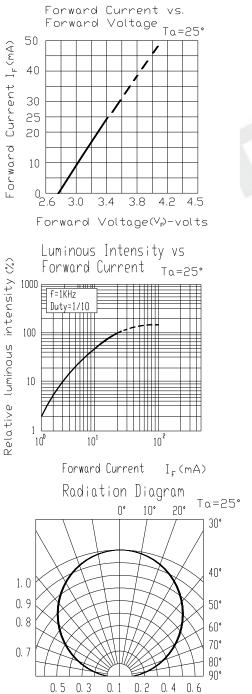




Typical Electro-Optical Characteristics Curves

BH







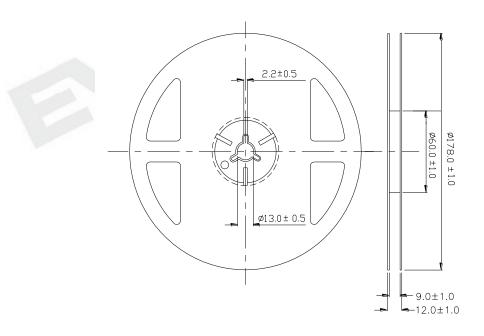
19-226/G7BHC-A01/2T

Label explanation

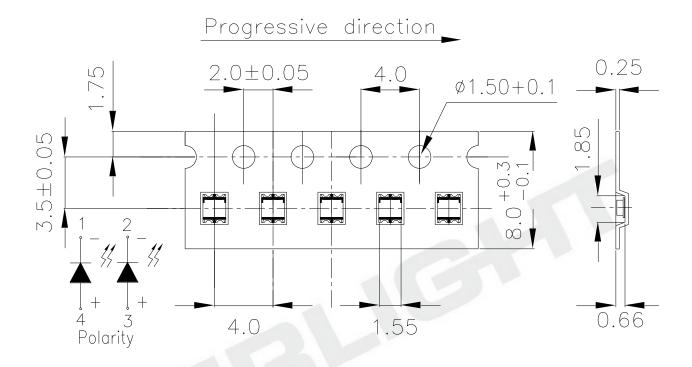
- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**



Reel Dimensions



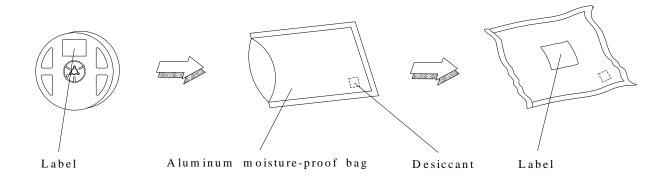
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel

Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD: 10%

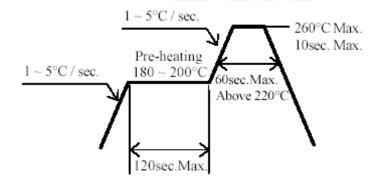
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100°C 15min $\int 5 \text{ min}$ L: -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min \int 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

